

# LNA2403F, LNA2402L (LN151F, LN151L)

## GaAs Infrared Light Emitting Diodes

For optical control systems

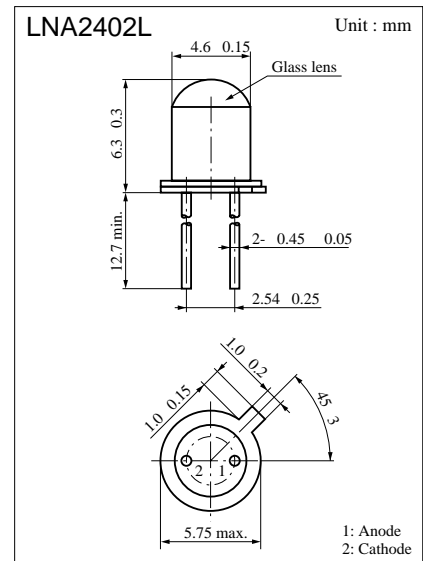
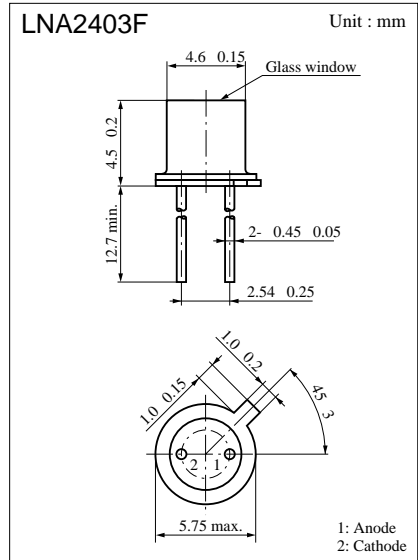
### ■ Features

- High-power output, high-efficiency :  $P_O = 7.5$  mW (typ.)
- Fast response and high-speed modulation capability :  
 $t_r, t_f = 1$   $\mu$ s (typ.)
- Infrared light emission close to monochromatic light :  
 $\lambda_p = 950$  nm (typ.)
- Narrow directivity, suitable for effective use of radiant power  
(LNA2402L (LN151L))
- Wide directivity, matched for external optical systems  
(LNA2403F (LN151F))
- TO-18 standard type package

### ■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Power dissipation	$P_D$	160	mW
Forward current (DC)	$I_F$	100	mA
Pulse forward current	$I_{FP}^*$	2	A
Reverse voltage (DC)	$V_R$	3	V
Operating ambient temperature	$T_{opr}$	-25 to +100	°C
Storage temperature	$T_{stg}$	-30 to +100	°C

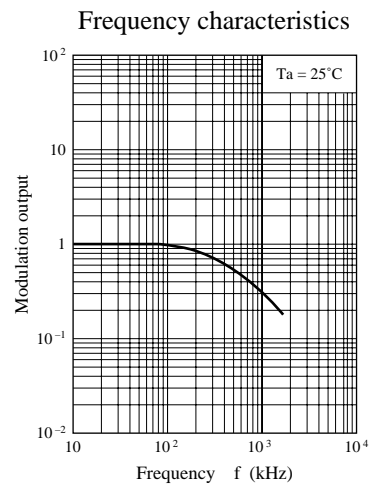
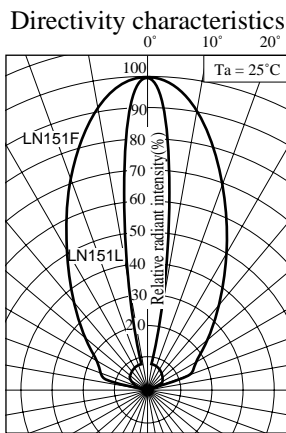
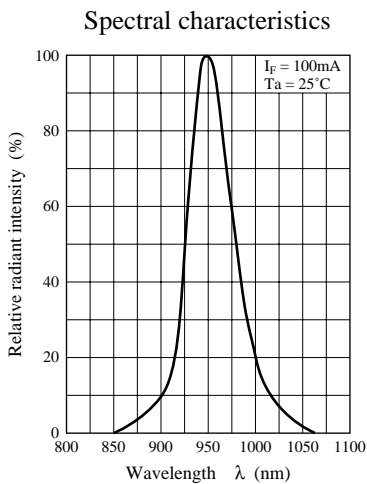
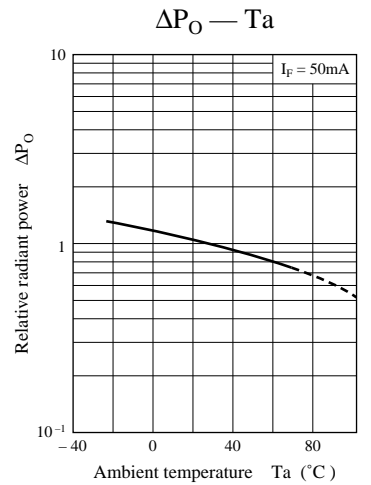
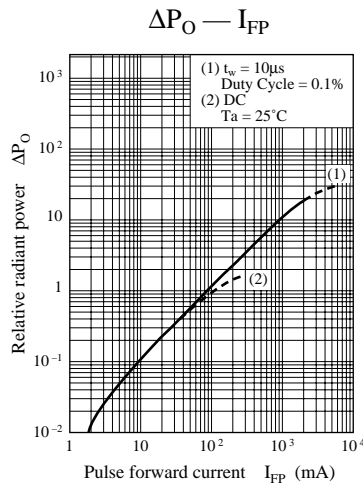
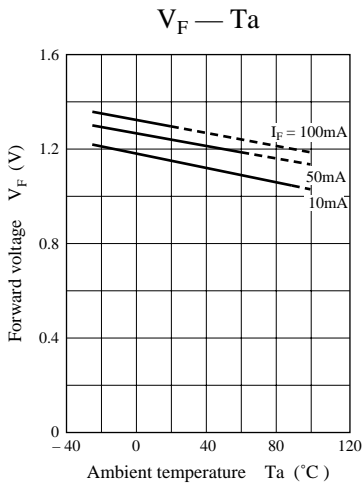
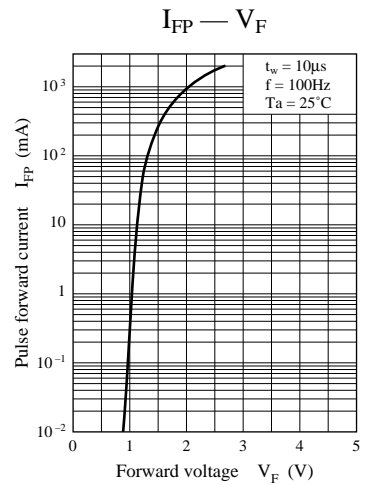
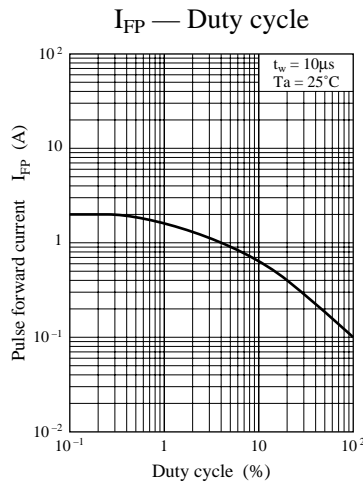
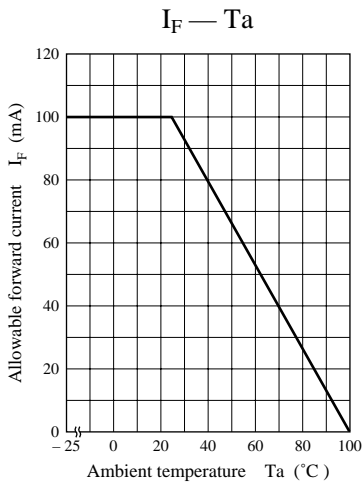
\* f = 100 Hz, Duty cycle = 0.1 %



### ■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Radiant power	$P_O$	$I_F = 100$ mA	5	7.5		mW
Peak emission wavelength	$\lambda_p$	$I_F = 100$ mA		950		nm
Spectral half band width	$\Delta\lambda$	$I_F = 100$ mA		50		nm
Forward voltage (DC)	$V_F$	$I_F = 100$ mA		1.3	1.6	V
Reverse current (DC)	$I_R$	$V_R = 3$ V			10	$\mu$ A
Capacitance between pins	$C_t$	$V_R = 0$ V, f = 1 MHz		60		pF
Rise time	$t_r$	$I_{FP} = 100$ mA		1		$\mu$ s
Fall time	$t_f$			1		$\mu$ s
Half-power angle	LNA2403F	$\theta$	The angle in which radiant intensity is 50%	32		deg.
	LNA2402L			8		deg.

Note) The part numbers in the parenthesis show conventional part number.



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 **DANGER**

Gallium arsenide material (GaAs) is used in this product.

Therefore, do not burn, destroy, cut, crush, or chemically decompose the product, since gallium arsenide material in powder or vapor form is harmful to human health.

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